74LVC2G17

DUAL SCHMITT TRIGGER BUFFER

NEW PRODUCT

Description

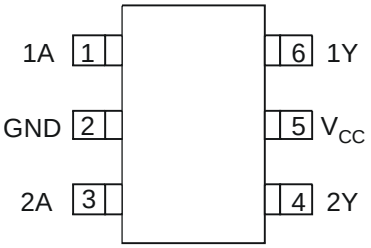
The 74LVC2G17 is a dual Schmitt trigger buffer gate with standard push-pull outputs. The device is designed for operation with a power supply range of 1.65V to 5.5V. The inputs are tolerant to 5.5V allowing this device to be used in a mixed voltage environment. The device is fully specified for partial power down applications using I_{OFF}. The I_{OFF} circuitry disables the output preventing damaging current backflow when the device is powered down.

The gate performs the positive Boolean function:

$Y = A$

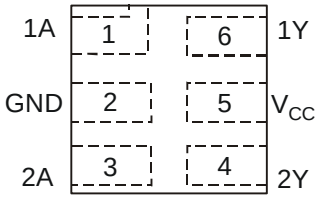
Pin Assignments

(Top View)



SOT26/SOT363

(Top View)



DFN1010

Features

- Wide Supply Voltage Range from 1.65V to 5.5V
- ±24mA Output Drive at 3.0V
- CMOS low power consumption
- IOFF Supports Partial-Power-Down Mode Operation
- Inputs accept up to 5.5V
- ESD Protection Tested per JESD 22
  - Exceeds 200-V Machine Model (A115-A)
  - Exceeds 2000-V Human Body Model (A114-A)
  - Exceeds 1000-V Charged Device Model (C101)
- Latch-Up Exceeds 100mA per JESD 78, Class II
- Range of Package Options
- SOT26, SOT363, and DFN1010 Available in "Green" Molding Compound (no Br, Sb)
- Lead Free Finish/ RoHS Compliant (Note 1)

Applications

- Voltage Level Shifting
- General Purpose Logic
- Power Down Signal Isolation
- Wide array of products such as:
  - PCs, networking, notebooks, netbooks, PDAs
  - Computer peripherals, hard drives, CD/DVD ROM
  - TV, DVD, DVR, set top box
  - Cell Phones, Personal Navigation / GPS
  - MP3 players ,Cameras, Video Recorders

Notes: 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied. Please visit our website at http://www.diodes.com/products/lead_free.html.

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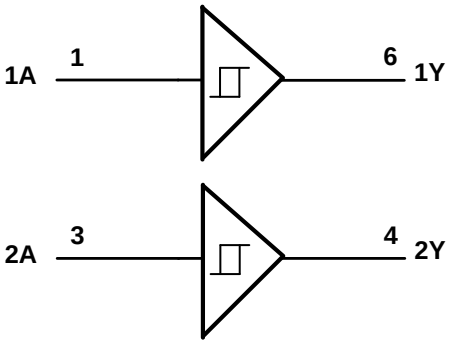
Pin Descriptions

Pin Name	Pin NO.	Description
1A	1	Data Input
GND	2	Ground
2A	3	Data Input
2Y	4	Data Output
V_{CC}	5	Supply Voltage
1Y	6	Data Output

Logic Diagram



Function Table

Inputs	Output
A	Y
H	H
L	L

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Absolute Maximum Ratings (Note 2)

Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	KV
ESD CDM	Charged Device Model ESD Protection	1	KV
ESD MM	Machine Model ESD Protection	200	V
V_{CC}	Supply Voltage Range	-0.5 to 6.5	V
V_I	Input Voltage Range	-0.5 to 6.5	V
V_O	Voltage applied to output in high impedance or I_{OFF} state	-0.5 to 6.5	V
V_O	Voltage applied to output in high or low state.	-0.3 to V_{CC} +0.5	V
I_{IK}	Input Clamp Current V_I<0	-50	mA
I_{OK}	Output Clamp Current	-50	mA
I_O	Continuous output current	±50	mA
	Continuous current through Vdd or GND	±100	mA
T_J	Operating Junction Temperature	-40 to 150	°C
T_{STG}	Storage Temperature	-65 to 150	°C

Notes: 2. Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.

Recommended Operating Conditions (Note 3)

Symbol	Parameter		Min	Max	Unit
V_{CC}	Operating Voltage	Operating	1.65	5.5	V
		Data retention only	1.5		V
V_I	Input Voltage		0	5.5	V
V_O	Output Voltage		0	V_{CC}	V
I_{OH}	High-level output current	V_{CC} = 1.65V		-4	mA
		V_{CC} = 2.3V		-8	
		V_{CC} = 3V		-16	
				-24	
		V_{CC} = 4.5V		-32	
I_{OL}	Low-level output current	V_{CC} = 1.65V		4	mA
		V_{CC} = 2.3V		8	
		V_{CC} = 3V		16	
				24	
		V_{CC} = 4.5V		32	
Δt/ΔV	Input transition rise or fall rate	V_{CC} = 1.8V ± 0.15V, 2.5V ± 0.2V		20	ns/V
		V_{CC} = 3.3V ± 0.3V		10	
		V_{CC} = 5V ± 0.5V		5	
T_A	Operating free-air temperature		-40	125	ºC

Notes: 3. Unused inputs should be held at V_{CC} or Ground.

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Electrical Characteristics

Symbol	Parameter	Test Conditions	V_{CC}	40ºC to 85ºC		-40ºC to 125ºC		Unit
				Min	Max	Min	Max	
V_{T+}	Positive-going input threshold Voltage		1.8V	0.70	1.50	0.70	1.70	V
			2.3V	1.00	1.80	1.00	2.00	
			3V	1.30	2.20	1.30	2.40	
			4.5V	1.90	3.10	1.90	3.30	
			5.5V	2.20	3.60	2.20	3.80	
V_{T-}	Negative-going input threshold Voltage		1.65V	0.25	0.90	0.39	1.10	V
			2.3V	0.40	1.15	0.25	0.87	
			3V	0.60	1.50	0.40	1.35	
			4.5V	1.00	2.00	0.60	1.70	
			5.5V	1.20	2.30	1.00	2.50	
ΔV_T	Hysteresis (V_{T+} - V_{T-})		1.8V	0.15	1.00	0.37	1.20	µA
			2.3V	0.25	1.10	0.15	1.30	
			3V	0.40	1.20	0.40	1.40	
			4.5V	0.60	1.50	0.60	1.70	
			5.5V	0.70	1.70	0.70	1.90	
V_{OH}	High Level Output Voltage	I_{OH} = -100 µA	1.65V to 4.5V	V_{CC} – 0.1		V_{CC} – 0.1		V
		I_{OH} = -4 mA	1.65V	1.2		0.95		
		I_{OH} = -8 mA	2.3V	1.9		1.7		
		I_{OH} = -16 mA	3V	2.4		1.9		
		I_{OH} = -24 mA		2.3		2.0		
		I_{OH} = -32 mA	4.5V	3.8		3.4		
V_{OL}	Low-Level Output Voltage	I_{OL} = 100 µA	1.65V to 4.5V		0.1		0.10	V
		I_{OL} = 4 mA	1.65V		0.45		0.70	
		I_{OL} = 8 mA	2.3V		0.3		0.45	
		I_{OL} = 16 mA	3V		0.4		0.60	
		I_{OL} = 24 mA			0.55		0.80	
		I_{OL} = 32 mA	4.5		0.55		0.80	
I_I	Input Current	V_I = 5.5 V or GND	0 to 5.5V		± 5		± 20	µA
I_{OFF}	Power Down Leakage Current	V_I or V_O = 5.5V	0		± 10		± 20	µA
I_{CC}	Supply Current	V_I = 5.5V of GND I_O=0	1.65V to 5.5V		10		40	µA

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Package Characteristics (All typical values are at V_{CC} = 3.3V, T_A = 25°C)

Symbol	Parameter	Test Conditions	V_{CC}	Min	Typ.	Max	Unit
C_I	Input Capacitance	V_I = V_{CC} – or GND	3.3		4		pF
θ_{JA}	Thermal Resistance Junction-to-Ambient	SOT26	(Note 4)		204		°C/W
		SOT363			371		
		DFN1010			430		
θ_{JC}	Thermal Resistance Junction-to-Case	SOT26	(Note 4)		52		°C/W
		SOT363			143		
		DFN1010			190		

Notes: 4. Test condition for SOT26, SOT363 and DFN1010: Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

Switching Characteristics

T_A = -40°C to 85°C, CL = 30 or 50pF (see Figure 1)

Parameter	From (Input)	TO (OUTPUT)	V_{CC} = 1.8V ± 0.15V		V_{CC} = 2.5V ± 0.2V		V_{CC} = 3.3V ± 0.3V		V_{CC} = 5V ± 0.5V		Unit
			Min	Max	Min	Max	Min	Max	Min	Max	
t_{pd}	A	Y	0.5	10.5	0.5	6.5	0.5	5.7	0.5	4.3	ns

T_A = -40°C to 125°C, CL = 30 or 50pF (see Figure 1)

Parameter	From (Input)	TO (OUTPUT)	V_{CC} = 1.8V ± 0.15V		V_{CC} = 2.5V ± 0.2V		V_{CC} = 3.3V ± 0.3V		V_{CC} = 5V ± 0.5V		Unit
			Min	Max	Min	Max	Min	Max	Min	Max	
t_{pd}	A	Y	0.5	13.1	0.5	8.5	0.5	7.1	0.5	5.4	ns

Operating Characteristics

T_A = 25 °C

Parameter		Test Conditions	V_{CC} = 1.8V	V_{CC} = 2.5V	V_{CC} = 3.3V	V_{CC} = 5V	Unit
			Typ.	Typ.	Typ.	Typ.	
C_{pd}	Power dissipation capacitance	f = 10 MHz	17	19	20	21	pF

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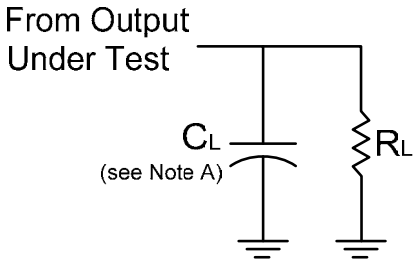
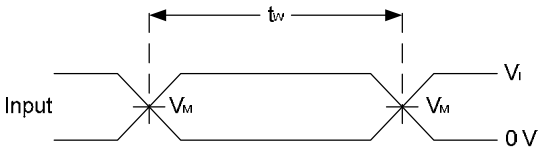
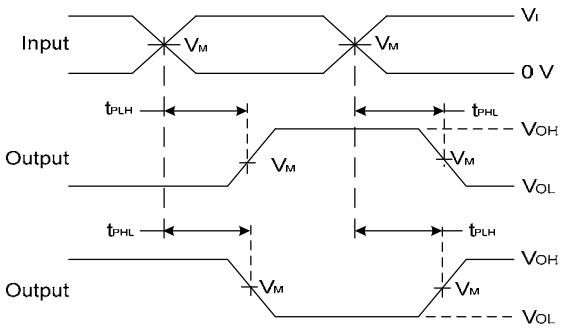
Parameter Measurement Information



V_{CC}	Inputs		V_M	C_L	R_L
	V_I	t_r/t_f			
1.8V±0.15V	V_{CC}	≤2ns	$V_{CC}/2$	30 pF	1 KΩ
2.5V±0.2V	V_{CC}	≤2ns	$V_{CC}/2$	30 pF	500 Ω
3.3V±0.3V	3 V	≤2.5ns	1.5V	50 pF	500 Ω
5V±0.5V	V_{CC}	≤2.5ns	$V_{CC}/2$	50 pF	500 Ω



Voltage Waveform Pulse Duration



Voltage Waveform Propagation Delay Times Inverting and Non Inverting Outputs

Figure 1. Load Circuit and Voltage Waveforms

Notes: A. Includes test lead and test apparatus capacitance.
B. All pulses are supplied at pulse repetition rate ≤ 10 MHz.
C. Inputs are measured separately one transition per measurement.
D. t_{PLH} and t_{PHL} are the same as t_{PD}.

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Ordering Information

74LVC2G 17 XX - 7

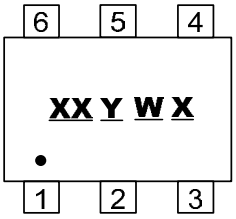
Logic Device	Function	Package	Packing
74 : Logic Prefix LVC : 1.65 to 5.5V Family 2G : Two gates	17 : Buffer/Driver Schmitt Trigger Inputs	W6 : SOT 25 DW : SOT363 FW4 : DFN1010	7 : Tape & Reel

Device	Package Code	Packaging (Note 5)	7" Tape and Reel	
			Quantity	Part Number Suffix
74LVC2G17W6-7	W6	SOT26	3000/Tape & Reel	-7
74LVC2G17DW-7	DW	SOT363	3000/Tape & Reel	-7
74LVC2G17FW4-7	FW4	DFN1010	5000/Tape & Reel	-7

Notes: 5. Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
6. The taping orientation is located on our website at http://www.diodes.com/datasheets/ap02007.pdf

Marking Information

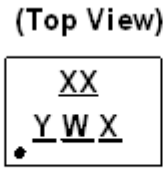
(1) SOT26, SOT363



XX : Identification code
Y : Year 0~9
W : Week : A~Z : 1~26 week;
a~z : 27~52 week; z represents 52 and 53 week
X : A~Z : Internal Code

Part Number	Package	Identification Code
74LVC2G17W6	SOT26	Z6
74LVC2G17DW	SOT363	Z6

(2) DFN1010



XX : Identification Code
Y : Year : 0~9
W : Week : A~Z : 1~26 week;
a~z : 27~52 week; z represents 52 and 53 week
X : A~Z : Internal code

Part Number	Package	Identification Code
74LVC2G17FW4	DFN1010	Z6

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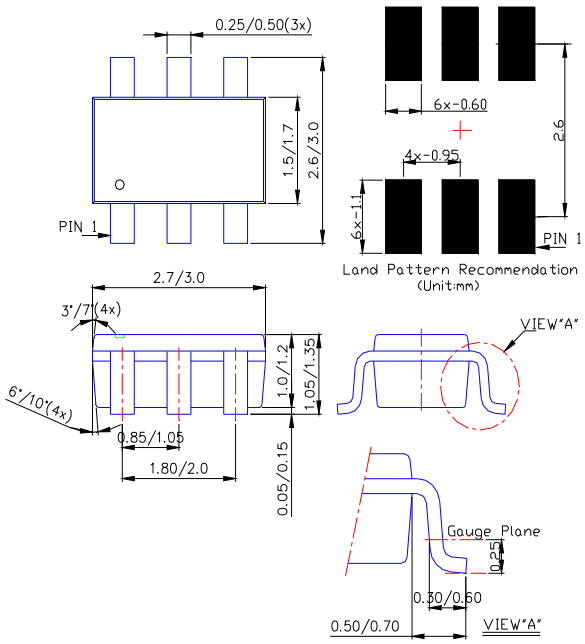
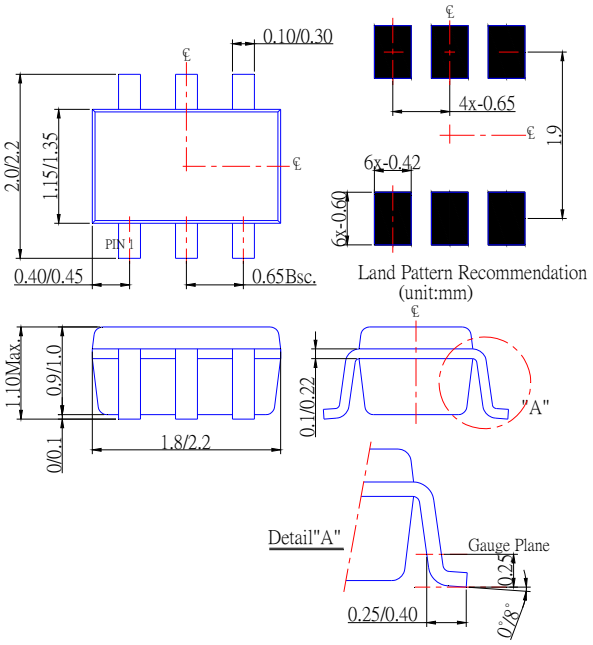
Package Outline Dimensions (All Dimensions in mm)

(1) Package Type: SOT26



(2) Package Type: SOT363



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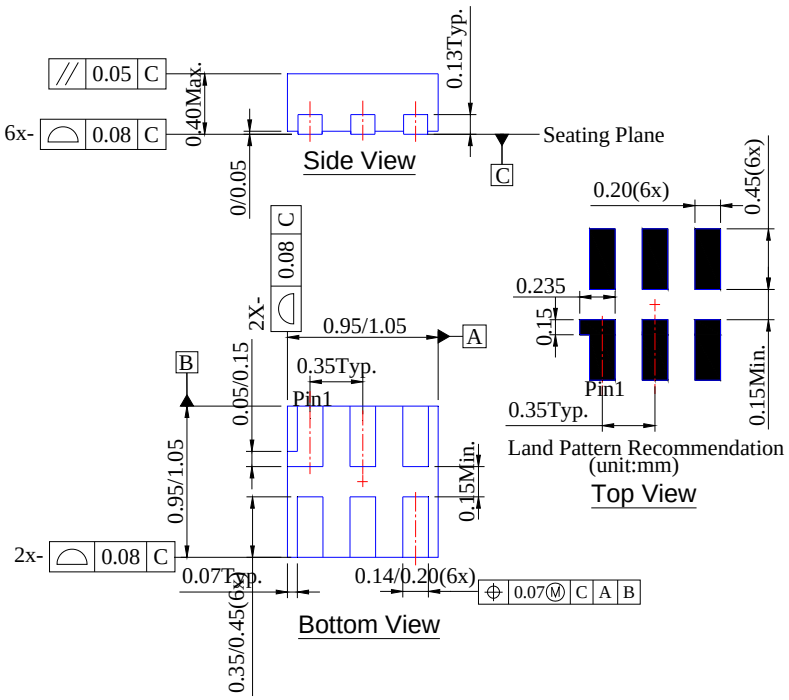
Package Outline Dimensions (All Dimensions in mm)

(3) Package Type: DFN1010



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